QSFPDD-400G-LR4-XXO

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400GBase QSFP-DD CWDM4 10km Reach

Features

- QSFP DD MSA rev5.0 compliant with CMIS Management
- Compliant with 400G-LR4-10 optical specifications
- Compliant to 802.3cd
- 4 CWDM lanes MUX/DEMUX design
- 53.125GBd PAM4x4 Transmitter
- Supports 425 Gb/s aggregate bit rate
- Maximum power consumption 8 W
- LC duplex connector
- Up to 10 km transmission on single mode fiber
- Single 3.3 V power supply
- RoHS 2 compliant



Applications

• 400G BASE-LR4 Ethernet

Part number

Product description

QSFPDD-400G-LR4-XXO

400GBase SMF QSFP-DD CWDM4 10km 0°C to 70°C LC Duplex DDM (8W)



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PIN Description

Din	-	Function/Description	
Pin		Function/Description	Notes
1	GND	Transmitter Ground (Common with Receiver Ground)	1
2	Tx2-	Transmitter Inverted Data Input	
3	Tx2+	Transmitter Non-Inverted Data output	
4	GND	Transmitter Ground (Common with Receiver Ground)	1
5	Tx4-	Transmitter Inverted Data Input	
6	Tx4+	Transmitter Non-Inverted Data output	
7	GND	Transmitter Ground (Common with Receiver Ground)	1
8	ModSelL	Module Select	
9	ResetL	Module Reset	
10	VccRx	3.3V Power Supply Receiver	2
11	SCL	2-Wire serial Interface Clock	
12	SDA	2-Wire serial Interface Data	
13	GND	Transmitter Ground (Common with Receiver Ground)	1
14	Rx3+	Receiver Non-Inverted Data Output	
15	Rx3 -	Receiver Inverted Data Output	
16	GND	Transmitter Ground (Common with Receiver Ground)	1
17	Rx1 +	Receiver Non-Inverted Data Output	
18	Rx1 -	Receiver Inverted Data Output	
19	GND	Transmitter Ground (C ommon with Receiver Ground)	1
20	GND	Transmitter Ground (Common with Receiver Ground)	1
21	Rx2-	Receiver Inverted Data Output	
22	Rx2+	Receiver Non-Inverted Data Output	
23	GND	Transmitter Ground (Common with Receiver Ground)	1
24	Rx4 -	Receiver Inverted Data Output	
25	Rx4+	Receiver Non-Inverted Data Output	
26	GND	Transmitter Ground (Common with Receiver Ground)	1
27	ModPrsl	Module Present	
28	IntL	Interrupt	
29	VccTx	3.3V power supply transmitter	2
30	Vcc1	3.3V power supply	2
31	LPMode	Low Power Mode	
32	GND	Transmitter Ground (Common with Receiver Ground)	1
33	Tx3+	Transmitter Non-Inverted Data Input	
34	Tx3-	Transmitter Inverted Data Output	
35	GND	Transmitter Ground (Common with Receiver Ground)	1
36	Tx1 +	Transmitter Non-Inverted Data Input	
37	Tx1 -	Transmitter Inverted Data Output	
38	GND	Transmitter Ground (Common with Receiver Ground)	1

Pin		Function/Description	Notes
39	GND	Transmitter Ground (Common with Receiver Ground)	1
40	Tx6-	Transmitter Inverted Data Input	
41	Tx6+	Transmitter Non-Inverted Data output	
42	GND	Transmitter Ground (Common with Receiver Ground)	1
43	Tx8-	TransmitterInverted Data Input	
44	Tx8+	Transmitter Non-Inverted Data output	
45	GND	Transmitter Ground (Common with Receiver Ground)	1
46	Reserved	For future use	3
47	VS1	Module Vendor Specific	3
48	VccRx1	3.3V Power Supply Receiver	2
49	VS2	Module Vendor Specific 2	3
50	VS3	Module Vendor Specific 3	3
51	GND	Transmitter Ground (Common with Receiver Ground)	1
52	Rx7+	Receiver Non-Inverted Data Output	
53	Rx7-	Receiver Inverted Data Output	
54	GND	Transmitter Ground (Common with Receiver Ground)	1
55	Rx5+	Receiver Non-Inverted Data Output	
56	Rx5-	Receiver Inverted Data Output	
57	GND	Transmitter Ground (C ommon with Receiver Ground)	1
58	GND	Transmitter Ground (Common with Receiver Ground)	1
59	Rx6-	Receiver Inverted Data Output	
60	Rx6+	Receiver Non-Inverted Data Output	
61	GND	Transmitter Ground (Common with Receiver Ground)	1
62	Rx8-	Receiver Inverted Data Output	
63	Rx8+	Receiver Non-Inverted Data Output	
64	GND	Transmitter Ground (Common with Receiver Ground)	1
65	NC	No Connect	
66	Reserved	For future use	
67	VccTx1	3.3V power supply transmitter	2
68	Vcc2	3.3V power supply	2
69	Reserved	For future use	3
70	GND	Transmitter Ground (Common with Receiver Ground)	1
71	Tx7+	Transmitter Non-Inverted Data Input	
72	Tx7-	Transmitter Inverted Data Output	
73	GND	Transmitter Ground (Common with Receiver Ground)	1
74	Tx5+	Transmitter Non-Inverted Data Input	
75	Tx5-	Transmitter Inverted Data Output	
76	GND	Transmitter Ground (Common with Receiver Ground)	1

Notes:

1.

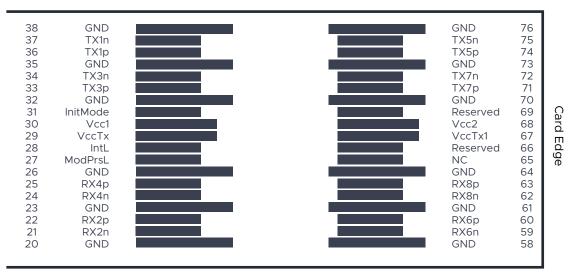
QSFP-DD uses common ground (GND) for all signals and supply (power). All are common within the QSFP-DD module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal-common ground plane.

2. VccRx, VccRx1, Vcc1, Vcc2, VccTx and VccTx1 shall be applied concurrently. Requirements defined for the host side of the Host Card Edge Connector are listed in the table. VccRx, VccRx1, Vcc1, Vcc2, VccTx and VccTx1 may be internally connected within the module in any combination. The connector Vcc pins are each rated for a maximum current of 1000 mA.

All Vendor Specific, Reserved and No Connect pins may be terminated with 50 Ω to ground on the host. Pad 65 (No Connect) shall be left unconnected within the module. Vendor specific and Reserved pads shall have an impedance to GND that is greater than 10 kΩ and less than 100 pF.

4. Plug Sequence specifies the mating sequence of the host connector and module.

Pin Assignment and Description



Top Side Viewed from Top



Bottom Side Viewed from Bottom

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Units	Notes
Storage Temperature	Ts	-40	85	°C	
Power Supply Voltage	Vcc	-0.5	4.0	V	
Relative Humidity (non-condensation)	RH	5	95	%	

Notes:

Exceeding any of these values may be harmful for the device

Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Units	
Operating Case Temperature	Тс	0	-	70	°C	
Supply Voltage	Vcc	3.13	3.3	3.47	V	
Data Rate each Lane	-	-	53.125	-	GBd/s	
Link Distance	-	-	-	10	km	

Transceiver Electrical Characteristics

Parameter	Min	Typical	Max	Units	Notes
Power Dissipation	-	-	8.0	W	-
Supply Current	-	-	2.60	А	-
Transmitter					
Input Differential Impedance	-	100	-	Ω	-
Differential Data Input Swing	180	-	900	mVp-p	-
Receiver					
Output Differential Impedance	-	100	-	Ω	-
Differential Data Output Swing	300	-	850	mVp-p	1

Notes:

1. Internally AC coupled, but requires a external 100 Ω differential load termination.

Transceiver Optical Characteristics

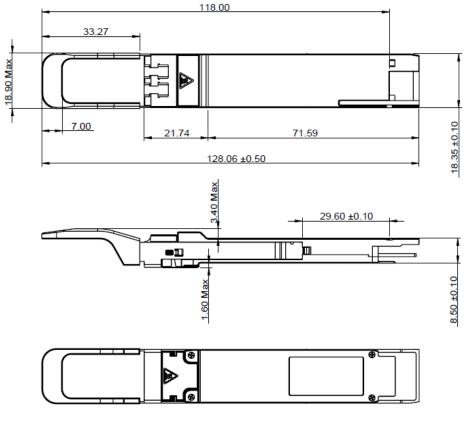
Parameter		Min	Typical	Max	Units	Notes
Transmitter						
Wavelengths	λ0 λ1 λ2 λ3	1264.5 1284.5 1304.5 1324.5	1271 1291 1311 1331	1277.7 1297.5 1317.5 1337.5	nm nm nm	1 1 1 1
Side-mode suppression ratio		30	-	-	dB	-
Total average launch power		-	-	10	dBm	-
Average launch power, per lan	e	-1.4	-	4.5	dBm	-
OMA per lane (min) (TDECQ<1.	4dB)	0.3	-	4.4	dBm	-
OMA per lane (min) (1,4 <tdec< td=""><td>Q<3,9dB)</td><td>-1,1+TDECQ</td><td>-</td><td>4.4</td><td>dBm</td><td>-</td></tdec<>	Q<3,9dB)	-1,1+TDECQ	-	4.4	dBm	-
Difference in launch power bet any two lanes (OMA outer)	ween	-	-	4	dB	-
Transmitter and dispersion eye for PAM4 (TDECQ), per lane	closure	-	-	3.9	dB	-
Transmitter eye closure for PAM4 (TECQ), per lane		-	-	3.9	dB	-
TDECQ-TECQ		-	-	2.5	dB	-
Exctinction Ratio		3.5	-	-	dB	-
Average launch power of OFF transmitter, per lane		-	-	-30	dBm	-
Optical Return Loss Tolerance		-	-	15.6	dB	-
Transmitter reflectance		-	-	-26	dB	-
Receiver						
Wavelengths	λ0 λ1 λ2 λ3	1264.5 1284.5 1304.5 1324.5	1271 1291 1311 1331	1277.7 1297.5 1317.5 1337.5	nm nm nm nm	- - -
Average Receiver Power, per I	ane	-9	-	5.1	dBm	-
Receiver Overload		5.1	-	-	dBm	-
Damage Threshold		6.1	-	-	dBm	-
Receive power, per lane (OMA outer)		-	-	4.4	dBm	-
Receiver Sensitivity per lane (OMA outer) (TECQ<1.4dB)		-	-	-6.8	dBm	2
Receiver Sensitivity per lane (OMA outer) (<1.4dBTECQ<3.9	dB)	-	-	-8.2+TECQ	dBm	2
LOS Assert		-16	-	-	dBm	-
LOS De-Assert		-	-	-10	dBm	-
LOS Hysteresis		0.5	-	-	dB	-

Notes:

The typical wavelengths compliant with 1310nm CWDM wavelength grids. Measured with PRBS31Q test pattern, 53.125GBd, PAM4, BER < 2.4×10^{-4} . 1.

2.

Mechanical specifications



Unit : mm

Revision history

Revision	Date	Author	Description
V1.1	13-11-2023	JGN	Initial Document

Note : Nexgen A/S reserves the right to change this document without notice.